



WHITE ELECTRONIC DESIGNS

Product Change Notification

Date: Monday, November 17, 2008
PCN#: #140A00170
Subject: W764M32V-XSBX, D50010 and D50031 die EOL notification

Dear Customer,

WEDC wishes to inform you that the Spansion S29GL512N die presently being used to support the W764M32V-XSBX, D50010 and D50031 product is transitioning to EOL and available at a limited supply at WEDC. WEDC has a LTB opportunity from Spansion until 1/5/09 so please contact your WEDC sales representative for specific product availability.

WEDC will continue to support the W764M32V-XSBX, D50010 and D50031 product after the depletion of the S29GL512N die and WEDC is evaluating die options for the future product. WEDC will provide a die change notification once a replacement die is selected.

As technology moves at a much faster pace, advanced embedded electronic components play a more strategic role. Constant changes and advancements in technology mandate that we anticipate changes and directions in technology for the benefit of our customers. As one of the pioneers in advanced semiconductor packaging and high-density memory solutions, we stand ready to assist you in managing this evolution of technology. If we can provide any additional assistance, please contact us at 602.437.1520 or complete a contact form at www.whiteedc.com/contact_us.html.

Best regards,

Bill Smith

Product Engineer

cc: Jane Myers

Laura Dufresne

Robert Barney

Ken Sicz

Kate Hopeman